UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/647,985	08/26/2003	Patricia Beauregard Smith	TI-33260	3087
	7590 03/02/200 UMENTS INCORPOI	EXAMINER		
PO BOX 6554	74, M/S 3999	GOLIGHTLY, ERIC WAYNE		
DALLAS, TX 75265			ART UNIT	PAPER NUMBER
			1792	
			NOTIFICATION DATE	DELIVERY MODE
			03/02/2009	ELECTRONIC

# Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

uspto@ti.com

		Application No.	Applicant(s)	
		10/647,985	SMITH ET AL.	
Office Action	n Summary	Examiner	Art Unit	
		Eric Golightly	1792	
The MAILING DAT Period for Reply	E of this communication app	pears on the cover sheet with the c	orrespondence address	
A SHORTENED STATUT WHICHEVER IS LONGE - Extensions of time may be availa after SIX (6) MONTHS from the r - If NO period for reply is specified - Failure to reply within the set or e	R, FROM THE MAILING DA ble under the provisions of 37 CFR 1.13 nailing date of this communication. above, the maximum statutory period wextended period for reply will, by statute, ater than three months after the mailing	Y IS SET TO EXPIRE 3 MONTH() ATE OF THIS COMMUNICATION (36(a). In no event, however, may a reply be time will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONEI (and the of this communication, even if timely filed).	N. lely filed the mailing date of this communication. (35 U.S.C. § 133).	
Status				
2a) ☐ This action is FINA 3) ☐ Since this application	on is in condition for allowar	ovember 2008. action is non-final. nce except for formal matters, pro Ex parte Quayle, 1935 C.D. 11, 45		
Disposition of Claims				
4a) Of the above class 5) ☐ Claim(s) is/a 6) ☑ Claim(s) is/a 7) ☐ Claim(s) is/a	<i>7,18 and 20-25</i> is/are rejecture objected to.	n from consideration.	iirement.	
Application Papers				
10) The drawing(s) filed Applicant may not red Replacement drawing	quest that any objection to the ogset(s) including the correct	r.  epted or b) objected to by the Education of the Education of the Education of the Education of the Education is required if the drawing(s) is objected.  Note the attached Office	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).	
Priority under 35 U.S.C. § 1	19			
<ul> <li>12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).</li> <li>a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority documents have been received.</li> <li>2. Certified copies of the priority documents have been received in Application No.</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>				
Attachment(s)  1) Notice of References Cited (P2) Notice of Draftsperson's Pate 3) Information Disclosure Staten	nt Drawing Review (PTO-948)	4)	ite	
Paper No(s)/Mail Date		6) Other:		

Application/Control Number: 10/647,985 Page 2

Art Unit: 1792

#### **DETAILED ACTION**

1. The response filed 11/14/2008 is acknowledged. Claims 1-6, 8-15, 17, 18 and 20-25 are pending. Claims 20-23 are withdrawn. Claims 7, 16 and 19 are cancelled. Claims 24 and 25 are new.

## Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. The factual inquiries set forth in *Graham* v. *John Deere Co.*, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:
  - 1. Determining the scope and contents of the prior art.
  - 2. Ascertaining the differences between the prior art and the claims at issue.
  - 3. Resolving the level of ordinary skill in the pertinent art.
  - 4. Considering objective evidence present in the application indicating obviousness or nonobviousness.
- 4. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicants are advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the

examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

5. Claims 1, 8-15, 17, 18, 24 and 25 are rejected under 35 U.S.C. 103(a) as being unpatentable over US 6,030,891 to Tran et al. (hereinafter "Tran").

Regarding claims 1, 8-15 and 18, Tran teaches a method of cleaning a wafer (abstract), comprising: patterning a via (col. 3, lines 52 and 53) in a porous, low-k dielectric layer (col. 3, line 65 to col. 4, line 8); cleaning a polymer residue from surfaces of the patterned dielectric layer using a wet clean solvent (col. 4, lines 52 and 53); performing a non-plasma anneal on the patterned dielectric layer prior to a barrier metal deposition (col. 5, lines 20-22), wherein the anneal comprises a low pressure anneal from about one atmosphere of pressure to substantial vacuum at about 250 °C (col. 6, lines 18-22); and after an anneal duration of about 45 seconds to about 2 minutes, stopping the anneal (col. 6, lines 23-25).

Tran discloses performing the anneal in order to remove moisture, i.e., water, absorbed during wet solvent cleaning (col. 7, lines 10-12) rather than annealing in order to remove a component of the solvent itself. However, solvents typically comprise a water component. Thus, it would have been obvious to one of ordinary skill in the art at the time of the invention that the component to be removed is water. It is noted that the annealing conditions themselves (pressure and duration) in the method as per the Tran method read on the conditions of the present application. Thus, the fact that applicant has recognized another advantage which would flow naturally from following the

suggestion of the prior art cannot be the basis for patentability when the differences would otherwise be obvious. See *Ex parte Obiaya*, 227 USPQ 58, 60 (Bd. Pat. App. & Inter. 1985). Here, it would have been obvious to one of ordinary skill in the art at the time of the invention to remove a volatile component of the solvent itself due, inter alia, to the similarity of reasons given for performing the anneal between the method of the Tran teaching and the method of the present application is noted. That is, Tran discloses that the anneal is meant to inhibit absorbed moisture from volatilizing during subsequent steps (col. 6, lines 8-15), while the present application discloses that the anneal is meant to inhibit absorbed components of the solvent from volatilizing during subsequent steps (abstract). Thus, the skilled artisan would find it obvious in view of Tran to remove absorbed sources of volatilizing substances, including solvent components, in order to inhibit void formation during outgassing (col. 6, lines 8-11).

Regarding claim 17, Tran discloses the method wherein the metal deposition includes a copper deposition (col. 7, lines 60-63).

Regarding claim 24, initially it is noted that care should be exercised when reciting negative limitations, as they may tend to define the invention in terms of what it is not, rather than pointing out the invention. Thus, a negative limitation can render a claim indefinite if it is an attempt to claim the invention by excluding what the inventors did not invent rather than distinctly and particularly pointing out what they did invent. In re Schechter, 205 F.2d 185, 98 USPQ 144 (CCPA 1953). Tran teaches photoresist removal, and discloses plasma stripping as a conventional technique of removal (col. 6, lines 1-8), i.e., as merely one possible removal technique. Thus, the skilled artisan

would find it obvious that techniques that do not subject the patterned via to a powered plasma before depositing the metal layer fall within the pale of the broader Tran teaching.

Regarding claim 25, Tran discloses annealing at a temperature of about 250 ℃ to about 400 ℃ for a duration of about 45 seconds to about 2 minutes (col. 6, lines 18-23), but does not explicitly teach annealing at a temperature of about 250 ℃ for a duration of about 45 seconds. However, the temperature and duration of annealing are result-effective variables in that higher temperatures and longer durations are known to result in increased drying. Thus, it would have been obvious to optimize the temperature and duration of annealing in order to enhance drying. See MPEP 2144.05(II). See discussion for claim 1, wherein a "component of the solvent" (claim 1, line 7) can be water (moisture). It is noted that the phrase "duration of about 45 seconds" in line 2 of claim 25 can be broadly, but reasonable interpreted to be openended, i.e., including at least 45 seconds and potentially more.

6. Claims 2, 5 and 6 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tran (US 6,030,891) in view of US 6,554,912 to Sahbari (hereinafter "Sahbari").

Regarding claim 2, Tran does not explicitly teach the claimed dielectric layers. Sahbari teaches a method of removing polymeric material from a substrate (abstract) and discloses using a silicon dioxide dielectrics layer (col. 7, lines 46-51), which is disclosed as advantageously having a low dielectric constant (id.). It would have been obvious to one of ordinary skill in the art at the time of the invention to use a silicon-

dioxide dielectric layer as per the Sahbari teaching in the method as per the Tran teaching due to the advantageously low dielectric constant of silicon-dioxide.

Regarding claims 5 and 6, Tran does not explicitly teach a dry clean. Sahbari discloses a dry clean prior to cleaning the residue (col. 8, lines 58-62), and further discloses that a wet clean, followed by a dry clean and a subsequent wet clean, which reads on a dry clean prior to cleaning the residue, enhances the cleaning (col. 1, lines 63-65). Sahbari discloses using a plasma including oxygen (Sahbari at col. 12, line 67). It would have been obvious to one of ordinary skill in the art at the time of the invention perform a dry clean prior to cleaning the residue as per the Sahbari teaching in the method as per the Tran teaching in order to enhance cleaning.

7. Claim 3 is rejected under 35 U.S.C. 103(a) as being unpatentable over Tran (US 6,030,891) in view of US 6,417,108 to Akino et al. (hereinafter "Akino").

Tran does not explicitly teach using a wet clean solvent comprising an acid.

Akino teaches a method of manufacturing a semiconductor substrate (abstract) and discloses using a wet clean solvent comprising hydrofluoric acid (col. 6, lines 30 and 31). It would have been obvious to one of ordinary skill in the art at the time of the invention to use a wet clean solvent comprising an acid as per the Akino teaching in the method as per the Tran teaching because hydrofluoric acid is known in the art and can remove silicon dioxide without removing silicon.

8. Claim 4 is rejected under 35 U.S.C. 103(a) as being unpatentable over Tran (US 6,030,891) in view of Akino (US 6,417,108) and in further view of Sahbari (US 6,554,912).

Tran and Akino do not explicitly teach using a solvent that comprises dimethyl acetamide ("DMAC"). Sahbari discloses using a solvent that comprises DMAC (col. 6, lines 33 and 34), which has an advantageous water miscibility (col. 6, lines 25 and 26). It would have been obvious to one of ordinary skill in the art at the time of the invention to use DMAC as per the Sahbari teaching in the method as per the Tran/Akino teachings due to its miscibility.

### Response to Arguments

9. Applicant's arguments, see Remarks at page 10, first paragraph through page 11, second paragraph, filed 11/14/2008, with respect to the rejection(s) of claim(s) 1-6, 8-15, 17 and 18 under 35 USC 103(a) have been fully considered and are persuasive. Therefore, the rejection has been withdrawn. However, upon further consideration, a new ground(s) of rejection is made as presented above.

### Conclusion

10. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Eric Golightly whose telephone number is (571) 270-3715. The examiner can normally be reached on Monday to Thursday, 7:30 AM to 5:00 PM.

Application/Control Number: 10/647,985 Page 8

Art Unit: 1792

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael Kornakov can be reached on (571) 272-1303. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

EWG /Michael Kornakov/ Supervisory Patent Examiner, Art Unit 1792